

60 A, 400 V - 600 V, Ultrafast Dual Diode

Description

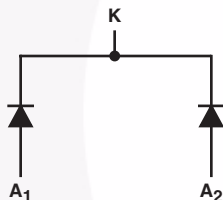
The RURG3040CC, RURG3060CC is an ultrafast dual diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RURG3040CC	TO-247-3L	RURG3040C
RURG3060CC	TO-247-3L	RURG3060C

NOTE: When ordering, use the entire part number.

Symbol



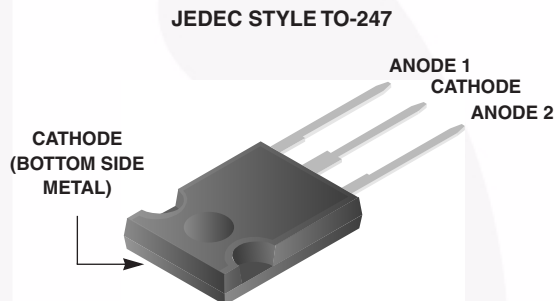
Features

- Ultrafast Recovery $t_{rr} = 60$ ns (@ $I_F = 30$ A)
- Max Forward Voltage, $V_F = 1.5$ V (@ $T_C = 25^\circ\text{C}$)
- 400 V, 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging



Absolute Maximum Ratings (Per Leg) $T_C = 25^\circ\text{C}$

	RURG3040CC	RURG3060CC	UNIT
Peak Repetitive Reverse Voltage	V_{RRM} 400	600	V
Working Peak Reverse Voltage	V_{RWM} 400	600	V
DC Blocking Voltage	V_R 400	600	V
Average Rectified Forward Current ($T_C = 130^\circ\text{C}$)	$I_{F(AV)}$ 30	30	A
Repetitive Peak Surge Current (Square Wave, 20kHz)	I_{FRM} 70	70	A
Nonrepetitive Peak Surge Current (Halfwave, 1 Phase, 60Hz)	I_{FSM} 325	325	A
Maximum Power Dissipation	P_D 125	125	W
Avalanche Energy (See Figures 7 and 8)	E_{AVL} 20	20	mJ
Operating and Storage Temperature	T_{STG}, T_J -65 to 175	-65 to 175	$^\circ\text{C}$

Electrical Specifications (Per Leg) $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
V_F	$I_F = 30\text{ A}$	-	-	1.5	-	-	1.5	V
	$I_F = 30\text{ A}$, $T_C = 150^\circ\text{C}$	-	-	1.3	-	-	1.3	V
I_R	$V_R = 400\text{ V}$	-	-	250	-	-	-	μA
	$V_R = 600\text{ V}$	-	-	-	-	-	250	μA
	$V_R = 400\text{ V}$, $T_C = 150^\circ\text{C}$	-	-	1.0	-	-	-	mA
	$V_R = 600\text{ V}$, $T_C = 150^\circ\text{C}$	-	-	-	-	-	1.0	mA
T_{rr}	$I_F = 1\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$	-	-	55	-	-	55	ns
t_{rr}	$I_F = 30\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$	-	-	60	-	-	60	ns
t_a	$I_F = 30\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$	-	30	-	-	30	-	ns
t_b	$I_F = 30\text{ A}$, $dI_F/dt = 100\text{ A}/\mu\text{s}$	-	20	-	-	20	-	ns
$R_{\theta JC}$		-	-	1.2	-	-	1.2	$^\circ\text{C}/\text{W}$

DEFINITIONS

V_F = Instantaneous forward voltage (pw = 300 μs , D = 2%).

I_R = Instantaneous reverse current.

T_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.

t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

$R_{\theta JC}$ = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

Typical Performance Curves

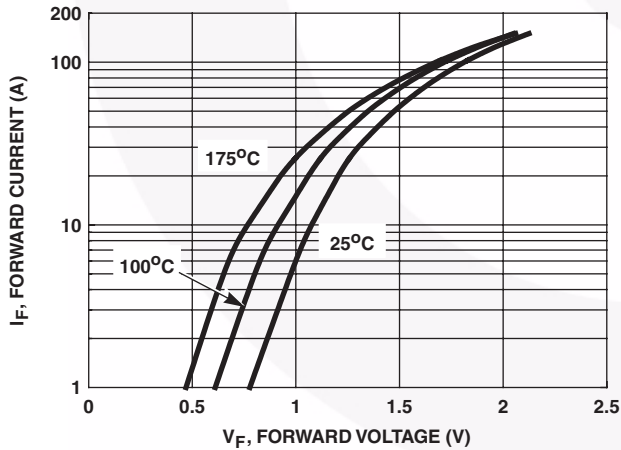


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

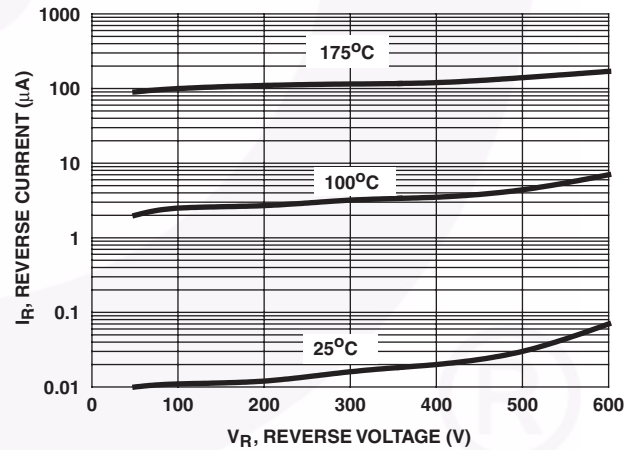


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

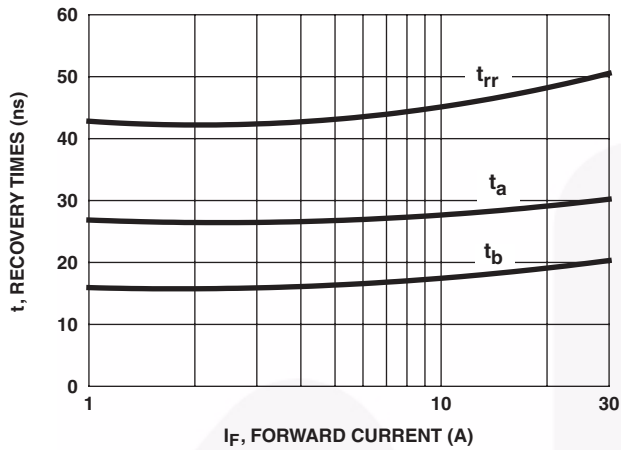


FIGURE 3. t_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT

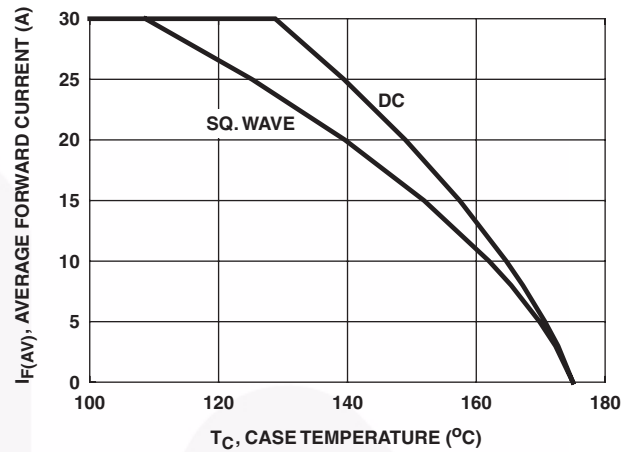


FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

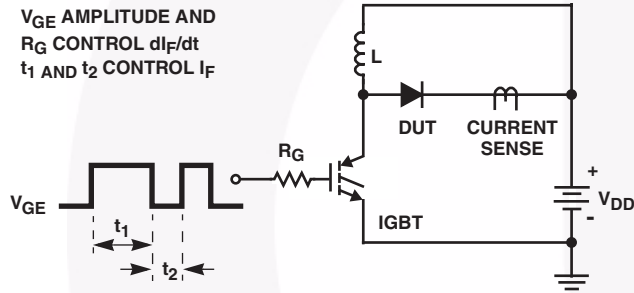


FIGURE 5. t_{rr} TEST CIRCUIT

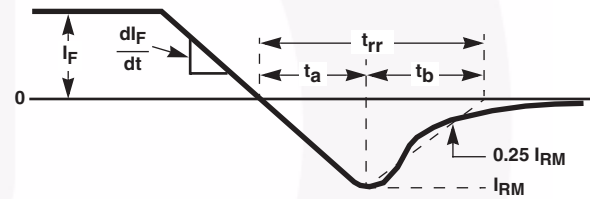


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

$I = 1A$
 $L = 40mH$
 $R < 0.1\Omega$
 $E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$
 $Q_1 = IGBT (BV_{CES} > DUT V_{R(AVL)})$

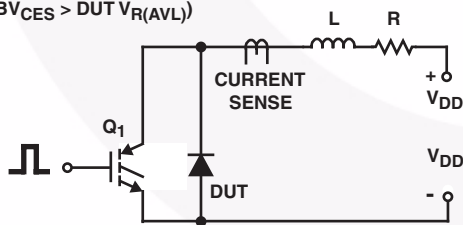


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

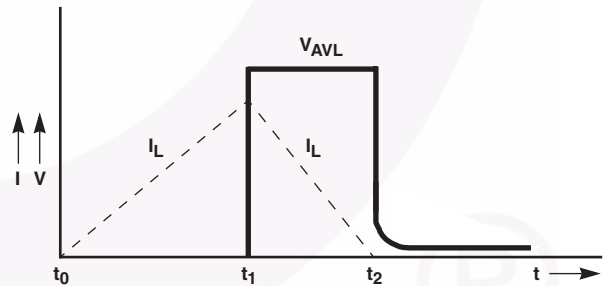
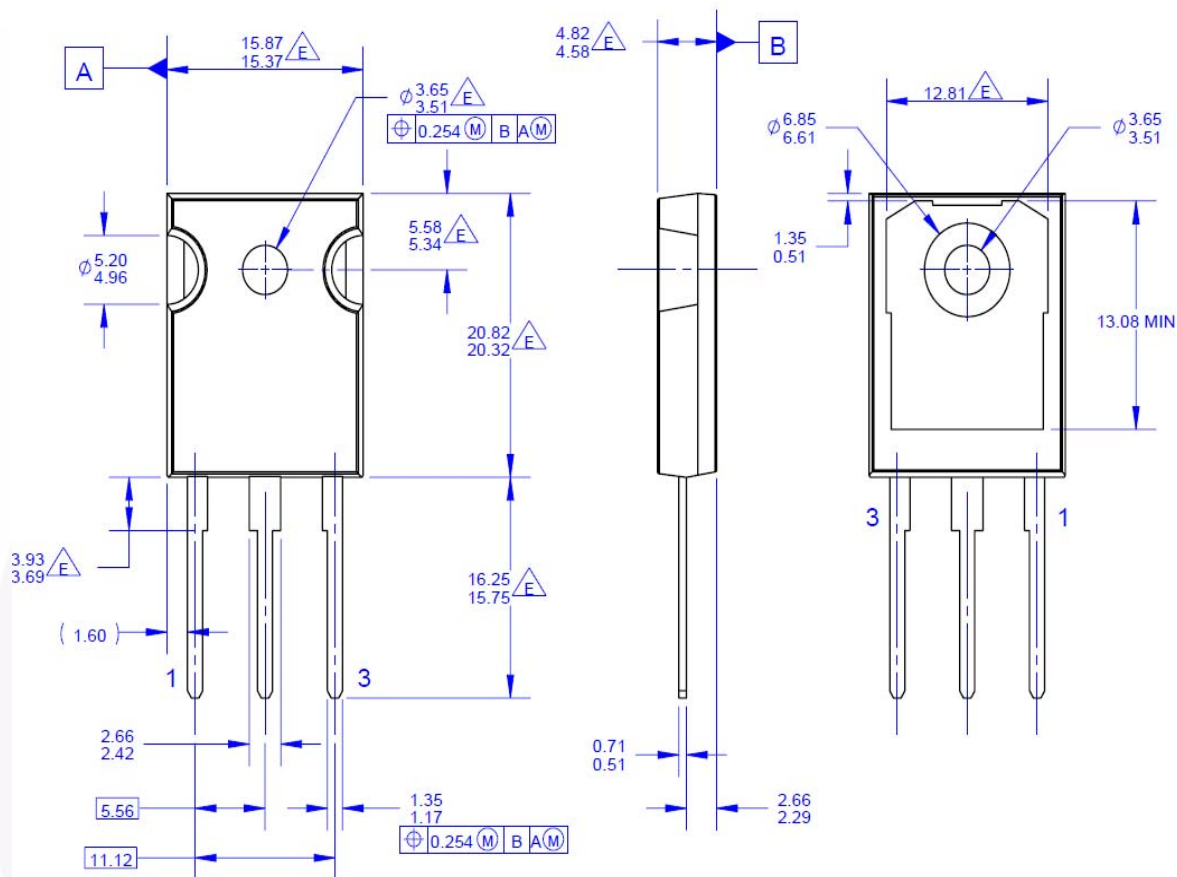


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

TO247-3L



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Figure 9. TO-247, Molded, 3LD, Jedec Option AB

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